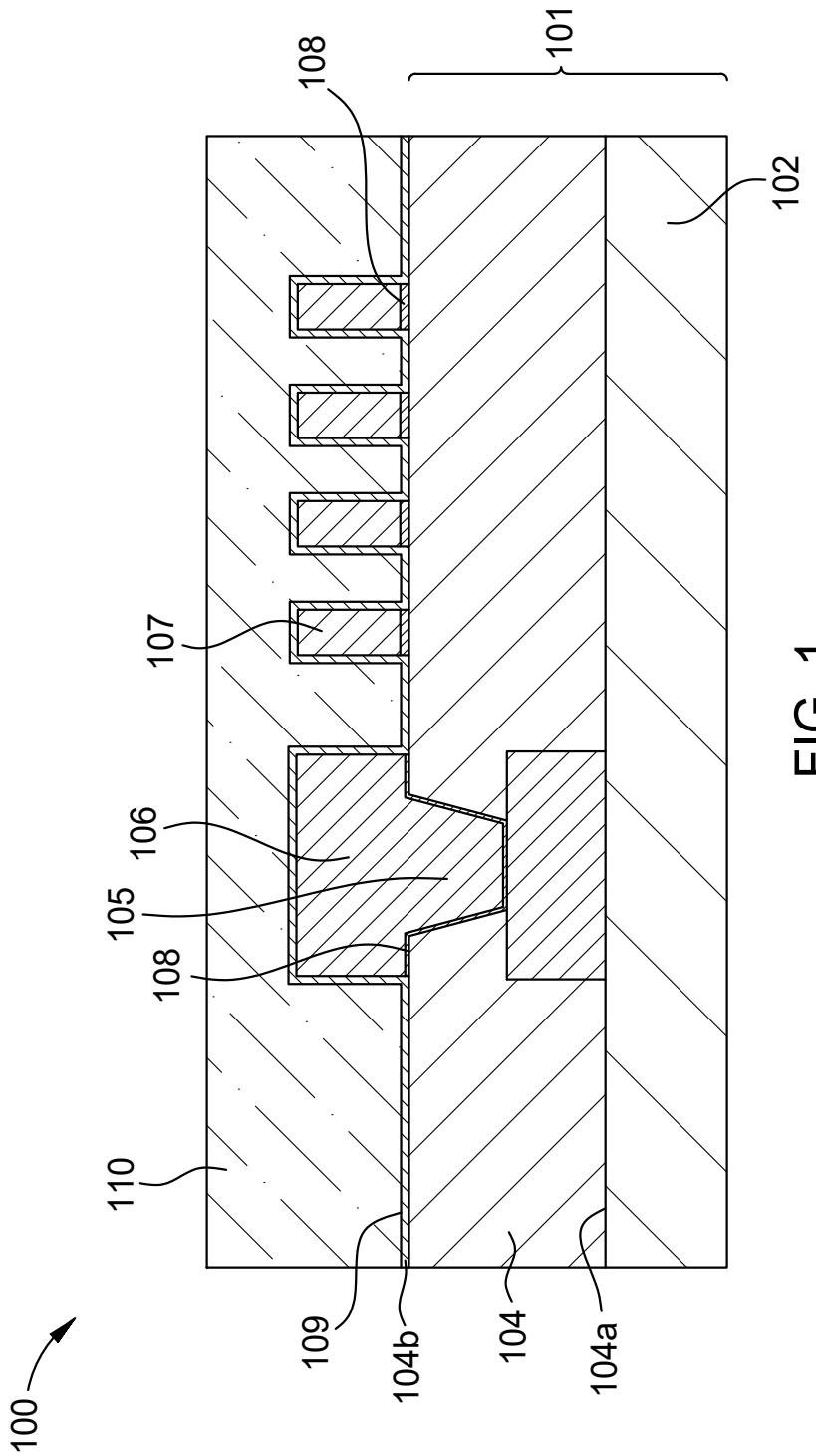


FIG. 1

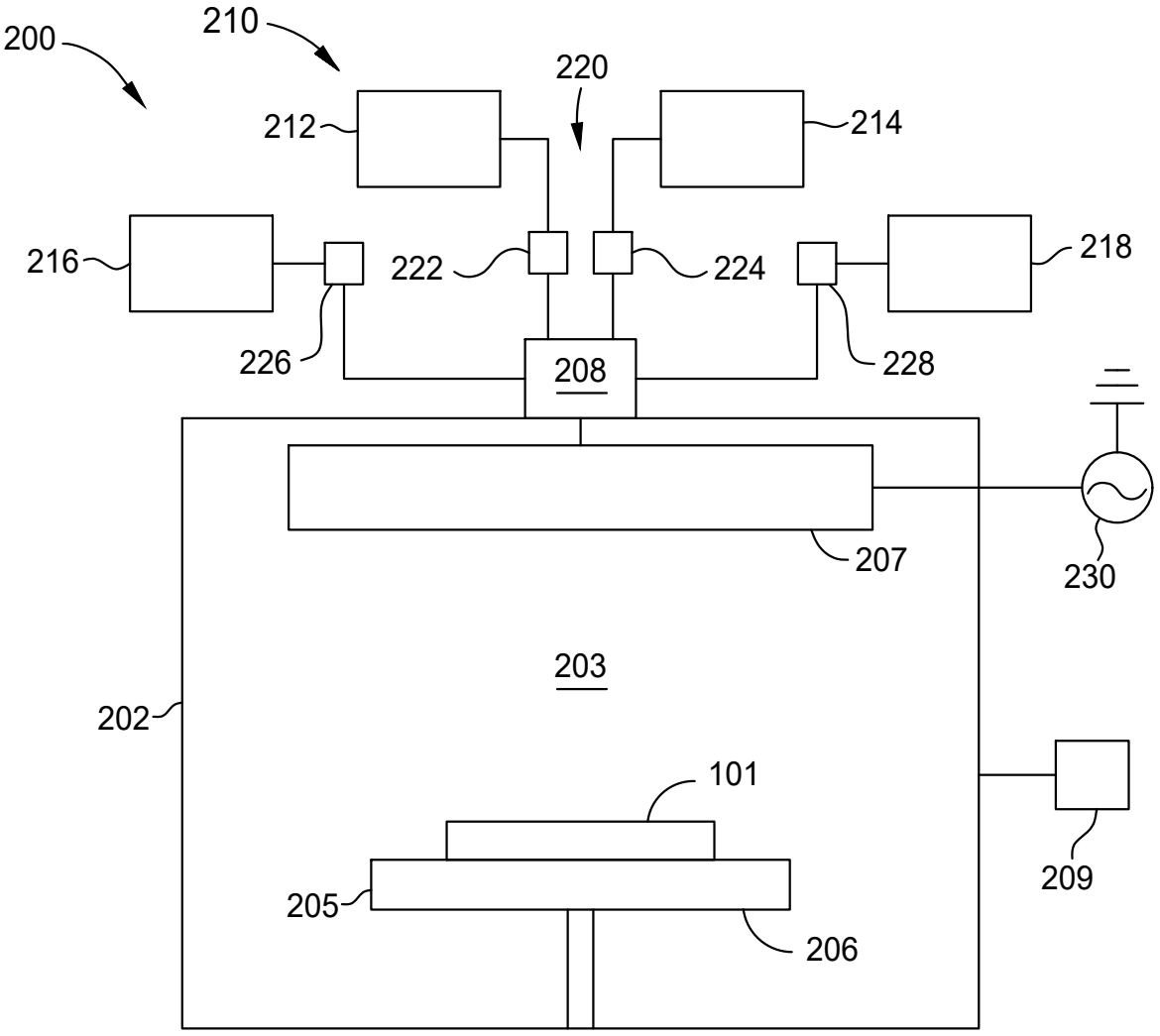

200
210
220
212
214
216
222
224
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226
228
208
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101
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FIG. 2

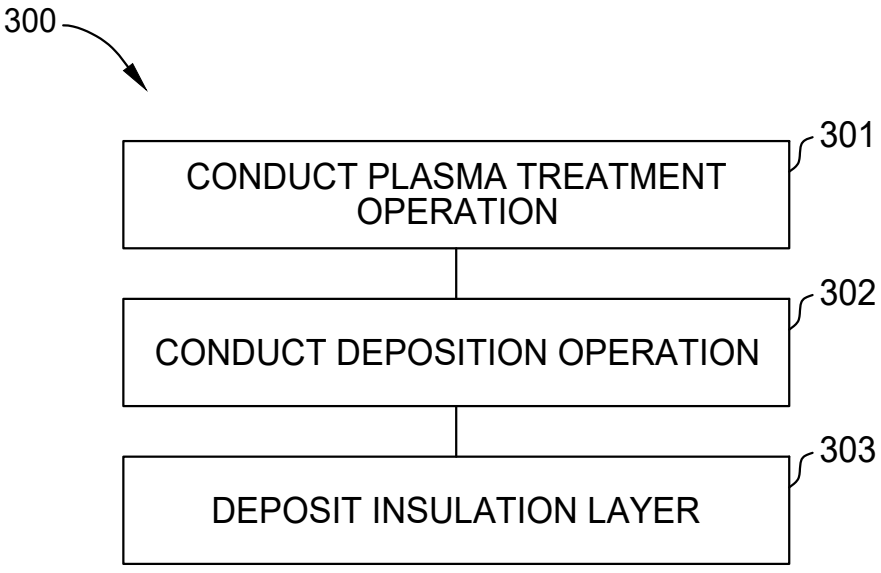

300
CONDUCT PLASMA TREATMENT OPERATION
301
CONDUCT DEPOSITION OPERATION
302
DEPOSIT INSULATION LAYER
303

FIG. 3

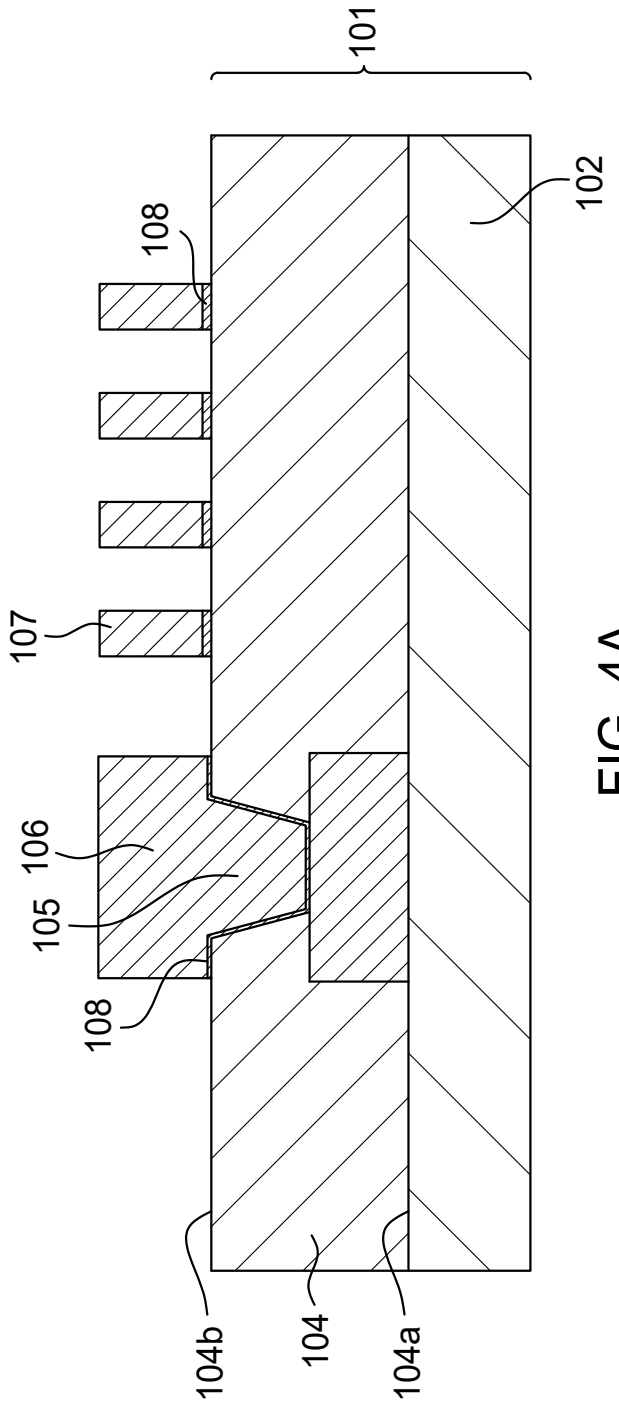


FIG. 4A

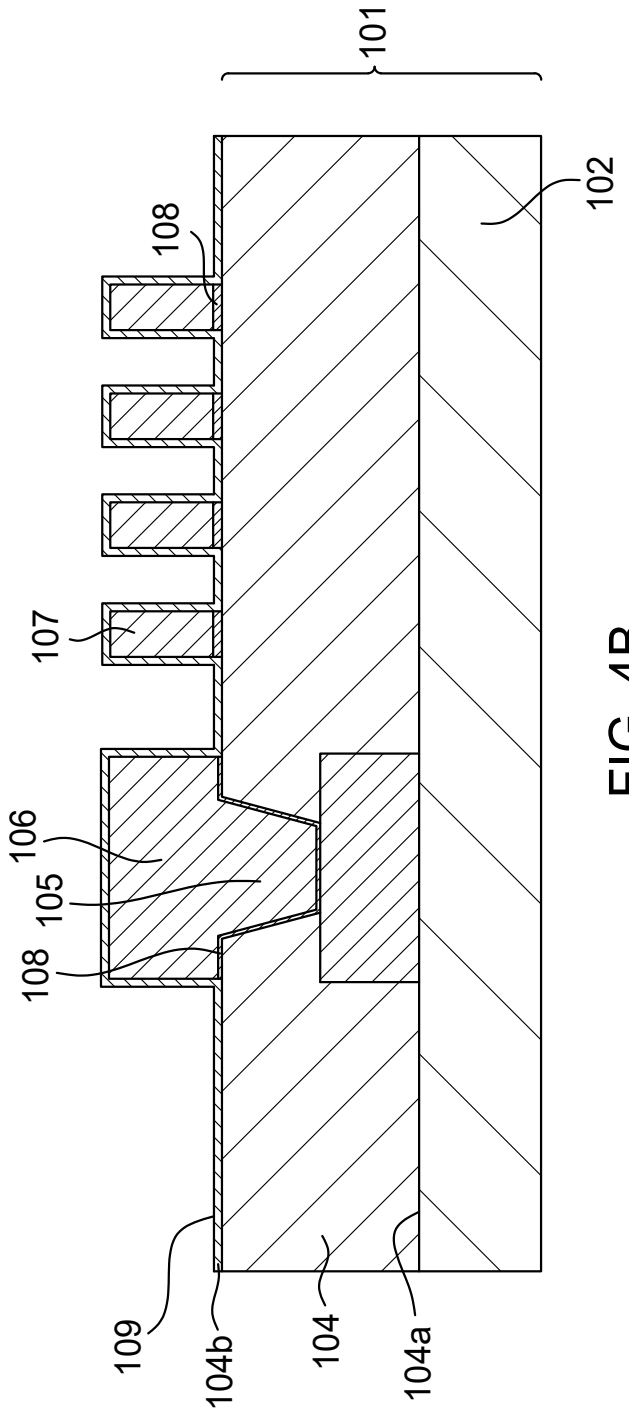


FIG. 4B